TOSHIBA Power Transistor Module Silicon NPN Triple Diffused Type (Four Darlington Power Transistors in One)

# **MP4015**

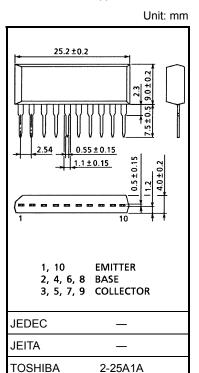
High Power Switching Applications Hammer Drive, Pulse Motor Drive Inductive Load Switching

- Small package by full molding (SIP 10 pins)
- High collector power dissipation (4-device operation)
   : PT = 4 W (Ta = 25°C)
- High collector current:  $I_{C(DC)} = 5 A \text{ (max)}$
- High DC current gain: hFE = 1000 (min) (VCE = 4 V, IC = 3 A)
- · Zener diode included between collector and base.
- Unclamped inductive load energy: ES/B = 100 mJ (min)

#### **Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Collector-base voltage		$V_{CBO}$	55	V	
Collector-emitter voltage		V <sub>CEO</sub>	60 ± 10	V	
Emitter-base voltage		V <sub>EBO</sub>	6	V	
Collector current	DC	I <sub>C</sub>	5	А	
	Pulse	I <sub>CP</sub>	8		
Continuous base current		Ι <sub>Β</sub>	0.5	Α	
Collector power dissipation (1-device operation)		P <sub>C</sub>	2.0	W	
Collector power dissipation (4-device operation)		P <sub>T</sub>	4.0	W	
Junction temperature		Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

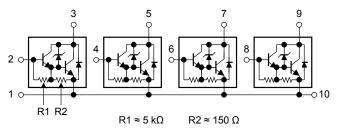
#### Industrial Applications

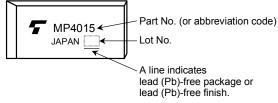


Weight: 2.1 g (typ.)

### **Array Configuration**

#### Marking





MP4015

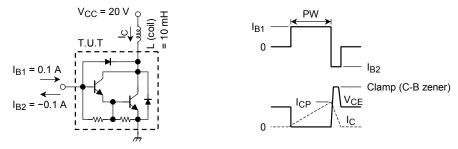


#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance from junction to ambient  (4-device operation, Ta = 25°C)	ΣR <sub>th (j-a)</sub>	31.3	°C/W	
Maximum lead temperature for soldering purposes (3.2 mm from case for 10 s)	TL	260	°C	

## **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Collector cut-off current		I <sub>CBO</sub>	V <sub>CB</sub> = 45 V, I <sub>E</sub> = 0 A	_	_	10	μA	
Collector cut-off current		I <sub>CEO</sub>	V <sub>CE</sub> = 45 V, I <sub>B</sub> = 0 A	_	_	10	μA	
Emitter cut-off current		I <sub>EBO</sub>	V <sub>EB</sub> = 6 V, I <sub>C</sub> = 0 A	0.3	-	10	mA	
Collector-base breakdown voltage		V (BR) CBO	I <sub>C</sub> = 10 mA, I <sub>E</sub> = 0 A	50	-	70	V	
DC current gain		h <sub>FE (1)</sub>	V <sub>CE</sub> = 4 V, I <sub>C</sub> = 1 A	1000	-	_	_	
		h <sub>FE (2)</sub>	V <sub>CE</sub> = 4 V, I <sub>C</sub> = 3 A	1000	_	_		
Saturation voltage	Collector-emitter	V <sub>CE</sub> (sat) (1)	I <sub>C</sub> = 1 A, I <sub>B</sub> = 4 mA	-	0.9	1.4	V	
		V <sub>BE</sub> (sat) (2)	I <sub>C</sub> = 3 A, I <sub>B</sub> = 10 mA	_	1.3	2.0		
	Base-emitter	V <sub>BE (sat)</sub>	I <sub>C</sub> = 1 A, I <sub>B</sub> = 4 mA	_	1.6	2.0		
Base-emitter voltage		V <sub>BE</sub>	V <sub>CE</sub> = 4 V, I <sub>B</sub> = 3 A	_	1.8	2.5	V	
Transition frequency		f <sub>T</sub>	V <sub>CE</sub> = 3 V, I <sub>C</sub> = 0.5 A		7	_	MHz	
Collector output capacitance		C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0 A, f = 1 MHz	_	44	_	pF	
Switching time	Turn-on time	t <sub>on</sub>	Output $B1$ $B1$ $C$ $C$ $C$ $C$ $C$ $C$ $C$	_	0.6	_	μs	
	Storage time	t <sub>stg</sub>		_	4.2	_		
	Fall time	t <sub>f</sub>		_	2.3	_		
Unclamped inductive load energy		E <sub>S/B</sub>	Refer to Figure 1	100	_	_	mJ	

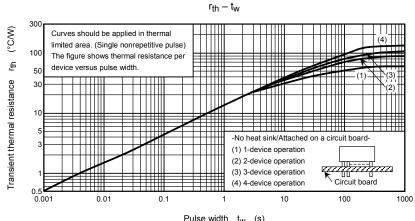


Note 1: Pulse width adjusted for desired  $I_{CP}$  ( $I_{CP}$  = 4.48 A min)

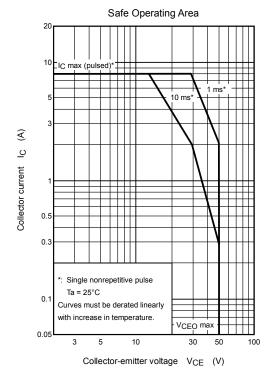
Note 2:  $E_{S/B} = \frac{1}{2} L \cdot I_{CP} 2$ 

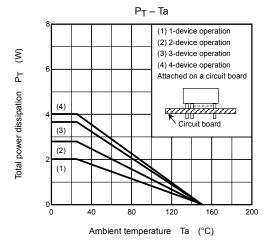
Figure 1 Measurement Circuit of Unclamped Inductive Load Energy E<sub>S/B</sub>

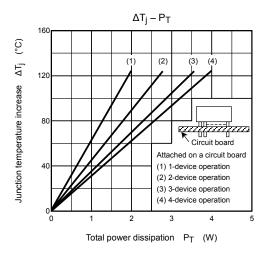
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